

●Features

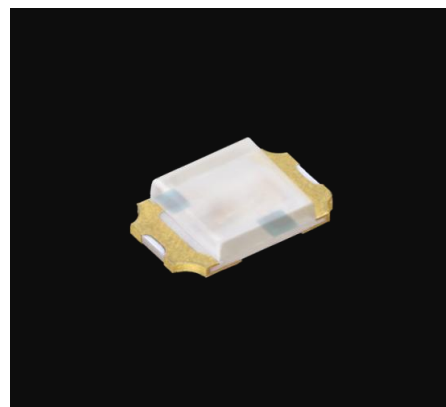
- Ultra compact, thin size 1.0×0.6mm
- Original device technology enables high brightness and high reliability
- Lead Free/RoHS Compliant.

●Size

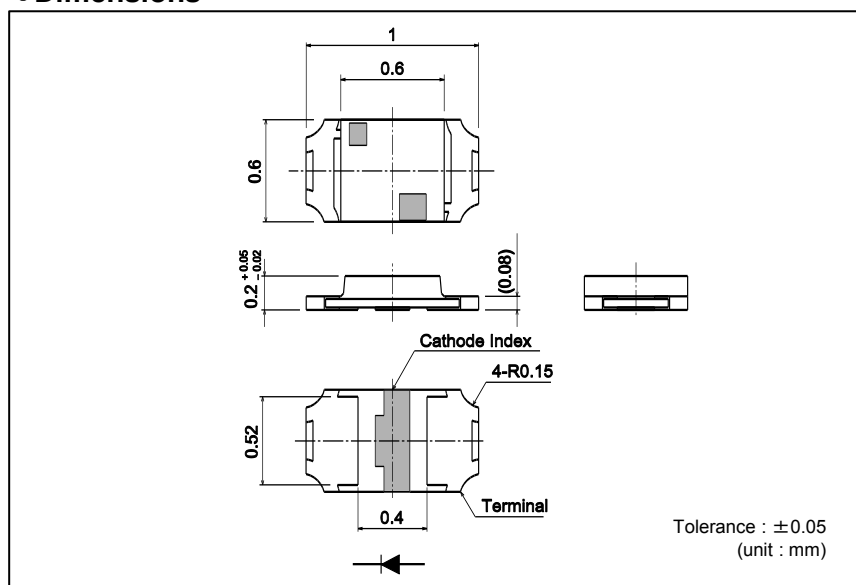
1006 (0402)
1.0 × 0.6mm (t=0.2mm)



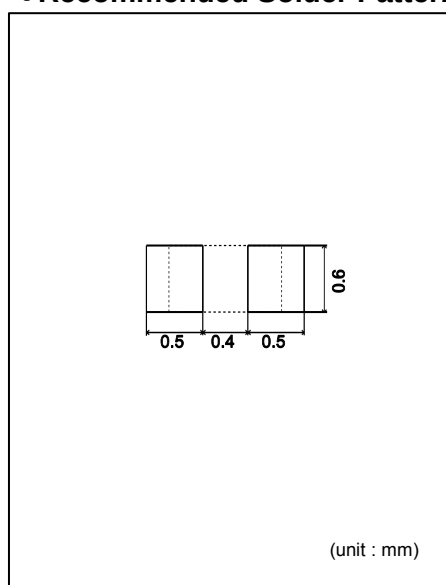
●Outline



●Dimensions



●Recommended Solder Pattern



●Specifications

Part No.	Chip Structure	Emitting Color	Absolute Maximum Ratings (Ta=25°C)						Electrical and Optical Characteristics (Ta=25°C)												
			Power Dissipation P _D (mW)	Forward Current I _F (mA)	Peak Forward Current I _{FP} (mA)	Reverse Voltage V _R (V)	Operating Temp. Topr(°C)	Storage Temp. Tstg(°C)	Forward Voltag V _F		Reverse Current I _R	Dominant Wavelength λ _D				Luminous Intensity I _v					
			Typ.	I _F	Max.	V _R	Min.*2	Typ.	Max.*2	I _F	Min.	Typ.	Max.*2	I _F	Min.	Typ.	I _F				
(V)	(mA)	(μA)	(V)	(nm)	(nm)	(nm)	(mA)	(mcd)	(mcd)	(mA)	(V)	(mA)	(μA)	(V)	(nm)	(nm)	(nm)	(mA)	(mcd)	(mcd)	(mA)
SML-P12VT(R)	AlGaInP on GaAs	Red	50	20	100*1	5	-40 to +85	-40 to +100	2.0	20	100	4	625	630	635	20	25	60	20		
SML-P12UT(R)		Red	50						2.0				615	620	625		85				
SML-P12DT(R)		Orange	52						2.1				602	605	608		100				
SML-P12YT(R)		Yellow	52						2.1				587	590	593		130				
SML-P12MT(R)		Yellowish Green	54						2.2				569	572	575		35				
SML-P12PT(R)		Green	54						2.2				557	560	563		13				
SMLP13EC8T	InGaN	Bluish Green	34	10	50*1	5	-40 to +85	-40 to +100	3.0	5	5	520	527	535	5	56	(110)	5			
SMLP13BC8T		Blue	33						2.9			465	470	475		9.0	(25)				
SCMP13WBC8W		White	33						2.9			(x, y) (0.30, 0.30)				90	150				

*PICOLED™ is ROHM's pending trademark.

*1 : Duty 1/10, 1kHz *2 : Reference

●Electrical Characteristics Curves

Fig.1 Forward Current - Forward Voltages

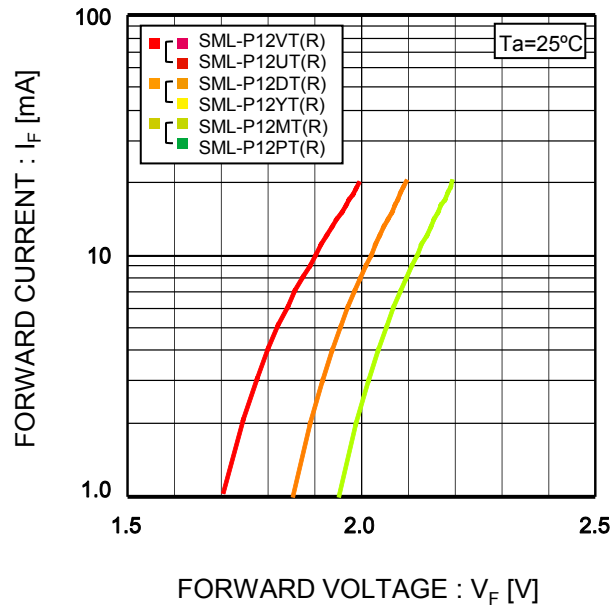


Fig.2 Luminous Intensity - Atmosphere Temperature

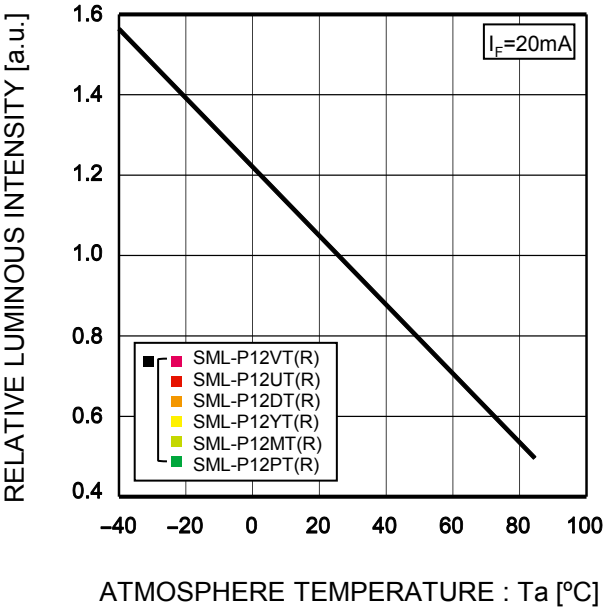


Fig.3 Luminous Intensity - Forward Current

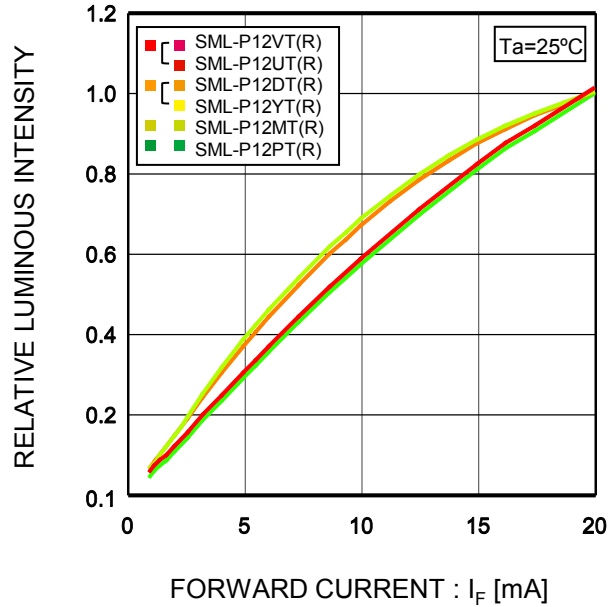
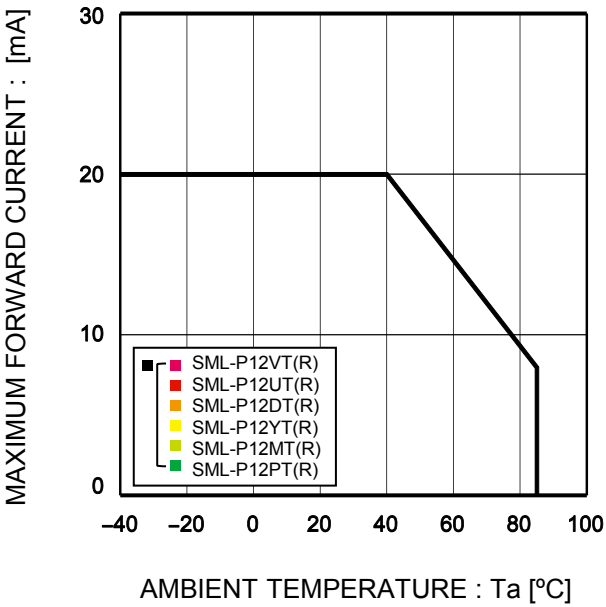


Fig.4 Derating



●Electrical Characteristics Curves

Fig.1 Forward Current - Forward Voltages

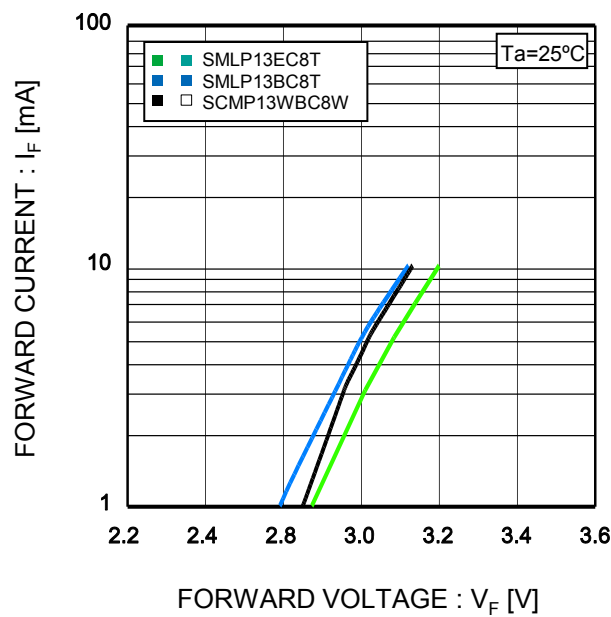


Fig.2 Luminous Intensity - Atmosphere Temperature

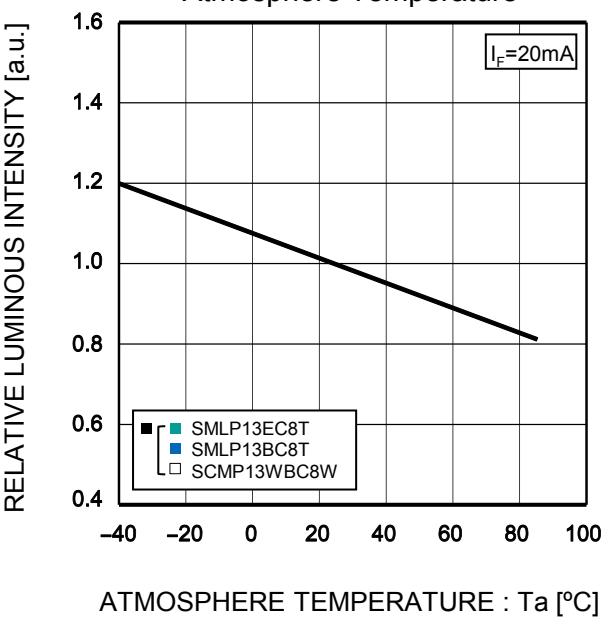


Fig.3 Luminous Intensity - Forward Current

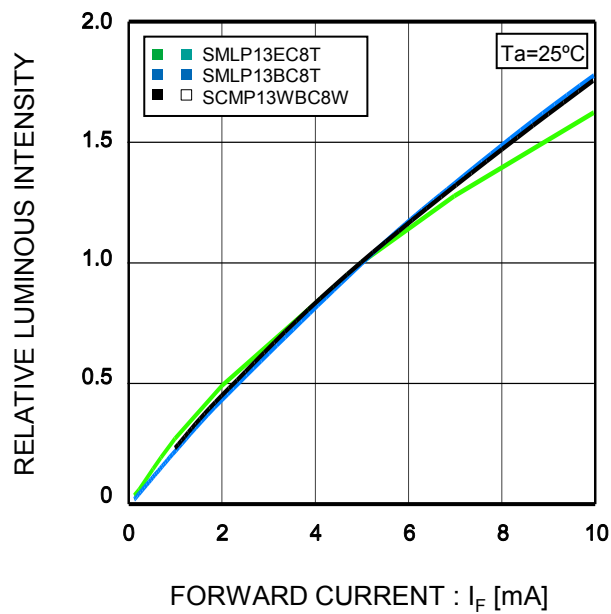
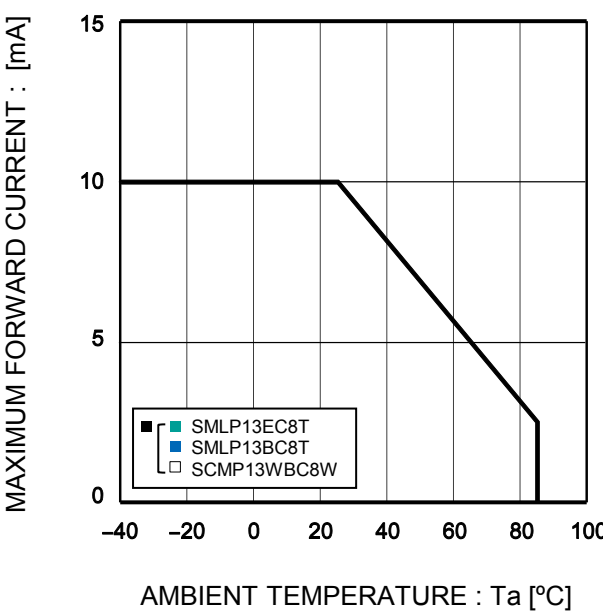
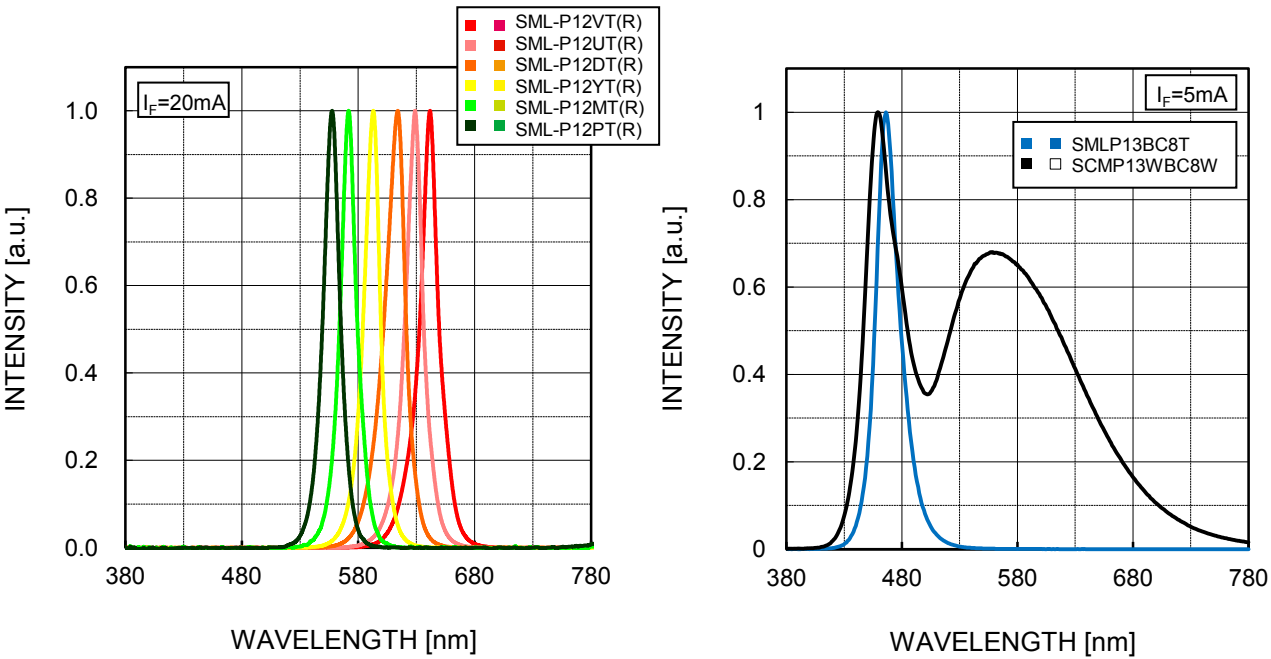


Fig.4 Derating

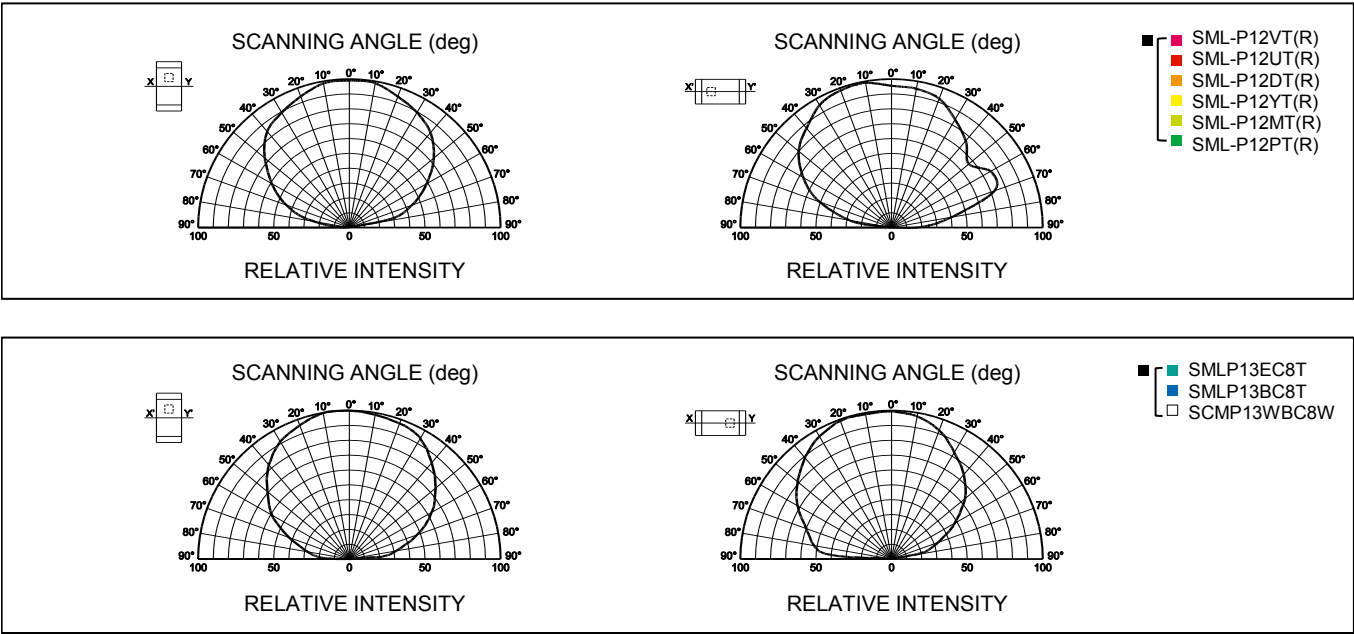


●Spectrum Data



* Please take this data as a reference data for the samples are measured randomly.
* The data is relativized for each color. It is NOT to show the spectrum peaks are equal.

●Viewing Angle



●Rank Reference of Brightness

Red(V,U)

(Ta=25°C, If=20mA)

Rank	G	H	J	K	L	M	N	P	Q	R	S	T	U	V	W	X
Iv (mcd)	1.0 to 1.6	1.6 to 2.5	2.5 to 4.0	4.0 to 6.3	6.3 to 10	10 to 16	16 to 25	25 to 40	40 to 63	63 to 100	100 to 160	160 to 250	250 to 400	400 to 630	630 to 1000	1000 to 1600
SML-P12VT																
SML-P12UT																

Orange(D)

(Ta=25°C, If=20mA)

Rank	G	H	J	K	L	M	N	P	Q	R	S	T	U	V	W	X
Iv (mcd)	1.0 to 1.6	1.6 to 2.5	2.5 to 4.0	4.0 to 6.3	6.3 to 10	10 to 16	16 to 25	25 to 40	40 to 63	63 to 100	100 to 160	160 to 250	250 to 400	400 to 630	630 to 1000	1000 to 1600
SML-P12DT																

Yellow(Y)

(Ta=25°C, If=20mA)

Rank	G	H	J	K	L	M	N	P	Q	R	S	T	U	V	W	X
Iv (mcd)	1.0 to 1.6	1.6 to 2.5	2.5 to 4.0	4.0 to 6.3	6.3 to 10	10 to 16	16 to 25	25 to 40	40 to 63	63 to 100	100 to 160	160 to 250	250 to 400	400 to 630	630 to 1000	1000 to 1600
SML-P12YT																

Green(M,P)

(Ta=25°C, If=20mA)

Rank	G	H	J	K	L	M	N	P	Q	R	S	T	U	V	W	X
Iv (mcd)	1.0 to 1.6	1.6 to 2.5	2.5 to 4.0	4.0 to 6.3	6.3 to 10	10 to 16	16 to 25	25 to 40	40 to 63	63 to 100	100 to 160	160 to 250	250 to 400	400 to 630	630 to 1000	1000 to 1600
SML-P12MT																
SML-P12PT																

Bluish Green(E)

(Ta=25°C, If=5mA)

Rank	G	H	J	K	L	M	N	P	Q	R	S	T	U	V	W
Iv (mcd)	0.9 to 1.4	1.4 to 2.2	2.2 to 3.6	3.6 to 5.6	5.6 to 9.0	9 to 14	14 to 22	22 to 36	36 to 56	56 to 90	90 to 140	140 to 220	220 to 360	360 to 560	560 to 900
SMLP13EC8T															

Blue(B)

(Ta=25°C, If=5mA)

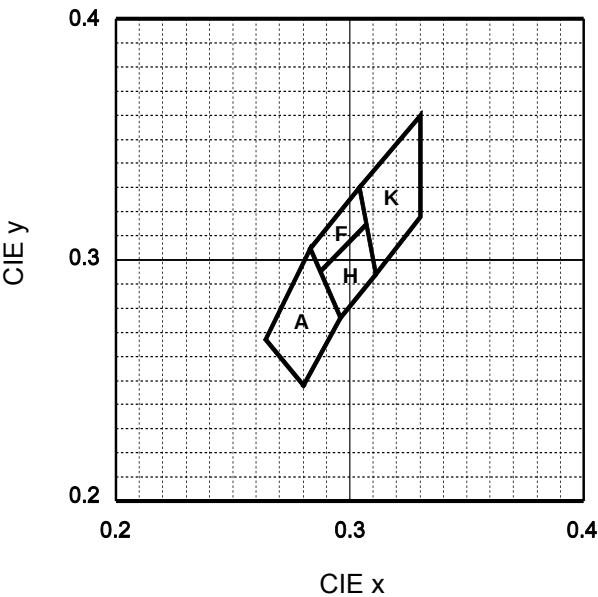
Rank	G	H	J	K	L	M	N	P	Q	R	S	T	U	V	W
Iv (mcd)	0.9 to 1.4	1.4 to 2.2	2.2 to 3.6	3.6 to 5.6	5.6 to 9.0	9 to 14	14 to 22	22 to 36	36 to 56	56 to 90	90 to 140	140 to 220	220 to 360	360 to 560	560 to 900
SMLP13BC8T															

White(WB)

(Ta=25°C, If=5mA)

Rank	N	P	Q	R	S	T	U	V	W
Iv (mcd)	14 to 22	22 to 36	36 to 56	56 to 90	90 to 140	140 to 220	220 to 360	360 to 560	560 to 900
SCMP13WBC8W									

●Chromaticity Diagram



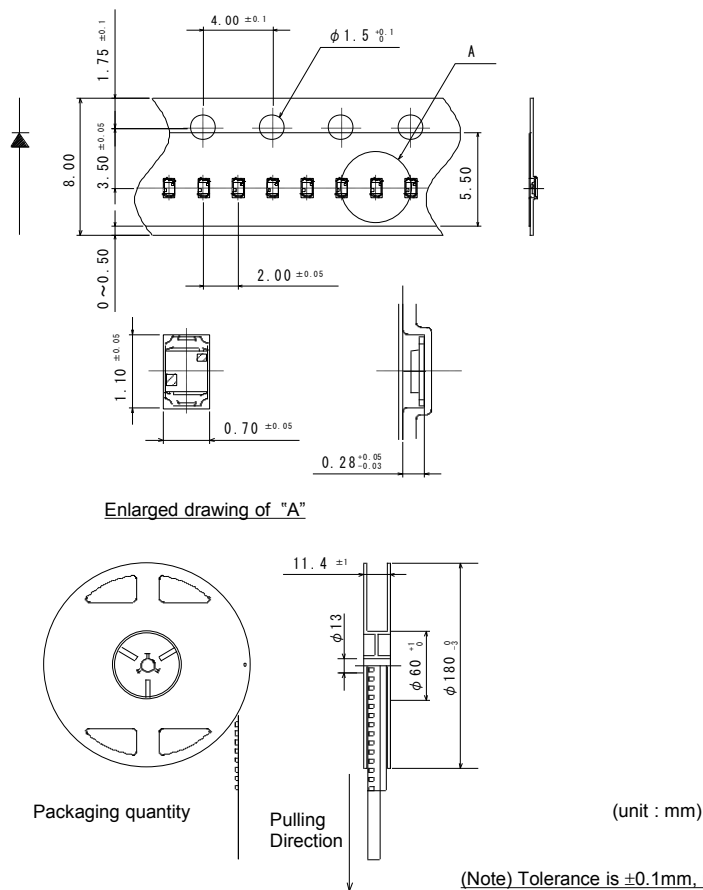
[Chromaticity Coordinates]

(Ta=25°C, If=5mA)

A		F		H		K	
x	y	x	y	x	y	x	y
0.28	0.248	0.283	0.305	0.287	0.295	0.304	0.33
0.296	0.276	0.304	0.33	0.307	0.315	0.33	0.36
0.283	0.305	0.307	0.315	0.311	0.294	0.33	0.318
0.264	0.267	0.287	0.295	0.296	0.276	0.311	0.294

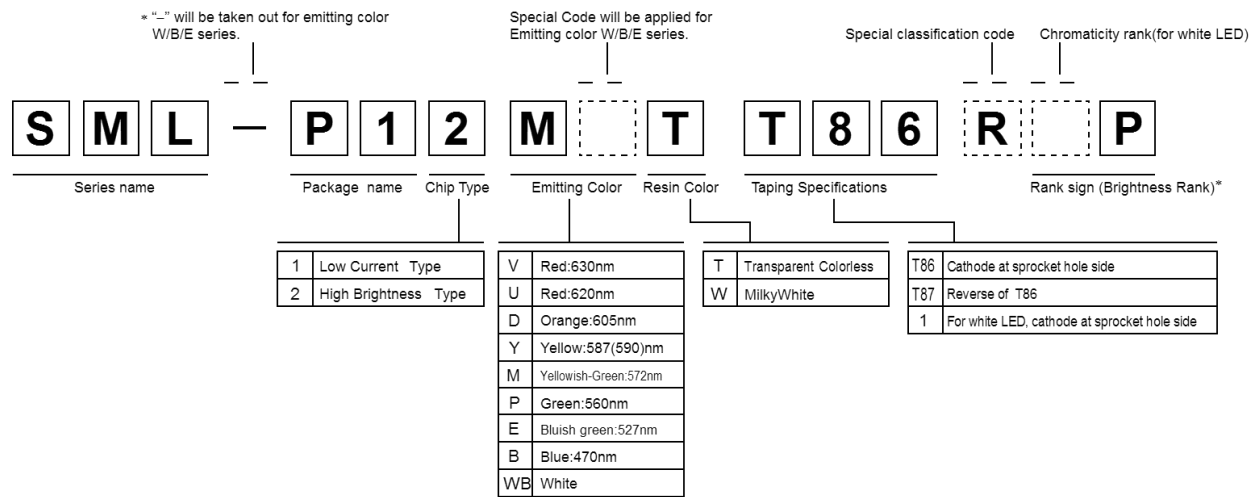
Measurement tolerance : ±0.02

●Taping



(Note) Tolerance is ± 0.1 mm, unless otherwise specified.

●Part No. Construction



●Packing Specification

ROHM LED products are being shipped with desiccant (silica gel) concluded in moisture-proof bags.

Pasting the moisture sensitive label on the outer surface of the moisture-proof bags or enclosing the humidity indication card inside the bag is available upon request.

Please contact the nearest sales office or distributor if necessary.

●Attention Points In Handling

This product was developed as a surface mount LED especially suitable for reflow soldering.
Please take care of following points when using this device.

1.DESIGNING OF PCB

As for a recommendable solder pattern, Please refer to Fig "Recommended Solder Pattern".

The size and direction of the pad pattern depend on the condition of the PCB.

- ⌈ This product of structured with rear/bottom electrode to be soldered.
- ⌋ The formation of solder fillet is not guaranteed due to its electrode shape

Reference

Mask open area ratio : 80%
Mask thickness : 80 to 100μm

Additional notification of mounting :

We recommend additional facility of mounting Machine due to small size package
which might be haven electrification, and product might be moved in the taping pocket.

And the mounting production efficiency will be decreased.

Ex) Magnet facility etc.

2.SOLDERING (Sn-Cu, Sn-Ag-Cu, Sn-Ag-Bi-Cu)

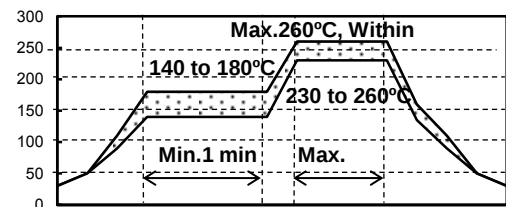
LED products do not contain reinforcement materials such as glass fillers.

Therefore, thermal stress by soldering greatly influences its reliability.

The temperature conditions for reflow soldering should therefore be set up according to the characteristic of this product. (See Fig-1)

Number of reflow process shall be max 2 times
and these processes shall be performed in a row.

Cooling process to normal temperature shall be required
between the first and the second soldering process.



(Fig-1)

SOLDERING OPERATION

1) SOLDER USED

Sn-Cu, Sn-Ag-Cu, Sn-Ag-Bi-Cu

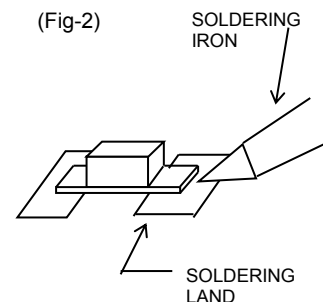
2) SOLDERING CONDITION

LED products do not contain reinforcement material such as a glass fillers.

So thermal stress by soldering greatly influence its reliability.

Please keep following points for manual soldering.

(Fig-2)



	ITEM	RECOMMENDED CONDITION
a)	Soldering iron	Less than 30W, top of iron less than 3mm.
b)	Heating method	Condition) Temp. of iron top less than 400°C within 3 sec. Heating on PCB pattern, not direct to the LED. (Fig-2)
c)	Handling after soldering	Please handle after the part temp. Goes down to room temp.

3.HANDLING AFTER MOUNTING (Fig.-3)

As shown in the drawing on the right, in case outside force of about 700g is given to the device, stress is concentrated to the jointed part between mold resin and substrate.

Therefore there is a possibility to breath the device or PCB.

Careful handing is needed as ROHM cannot guarantee the falling of the device by outside force after mounting.

4.WASHING

Please note the following points when washing is required after soldering.

4-1) WASHING SOLVENT

Isopropyl alcohol or other alcohol solvent is recommendable.

4-2) TEMPERATURE

Below 30°C, immersion time ; within 3 minutes.

4-3) ULTRA SONIC WASHING

Below 15W/1 litter of solvent tub or less.

4-4) COOLING

Below 100°C within 3 minutes.

5.EROSION GAS

Utilization in erosion gas atmosphere may degenerate the plating surface which might cause deterioration of solder strength, optical characteristics, or functions.

Please take precautions against occurrence of gas from the surrounding parts on the occasion of custody, and also after mounted on circuit board.

6.STORAGE

At reflow soldering, the reliability of this product is often influenced by moisture absorption so we apply the packaging with moisture proof for better condition is use, please also note that

6-1) Not to be opened before using.

6-2) To be kept in our moisture proof packaging with some desiccant (SILICA GEL) after opening it.

To be baked in case the SILICA GEL indicator its color from either blue to clear or green to pink.

6-3) Please use within 168 hours after the package was opened. (Condition at 30°C, max.70%Rh.)

In case it is not used within 168 hours, please put it back into our packaging.

6-4) BAKING

Please bake under reel condition at 60°C, 1 to 224 hours (max.20%Rh) after un-sealing.

While baking is done, the reel and emboss tape may be easily deformed.

Please be careful not to give any stress.

7.LIFE TIME

Blue led die used in this product will cause reduction of luminous intensity due to epoxy resin discoloration depending on the using conditions and environmental.

Please inquire our sales contact if long life time is required on your application.

Notes

- 1) The information contained herein is subject to change without notice.
- 2) Before you use our Products, please contact our sales representative and verify the latest specifications :
- 3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors.
Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Products beyond the rating specified by ROHM.
- 4) Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.
- 5) The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
- 6) The Products are intended for use in general electronic equipment (i.e. AV/OA devices, communication, consumer systems, gaming/entertainment sets) as well as the applications indicated in this document.
- 7) The Products specified in this document are not designed to be radiation tolerant.
- 8) For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative : transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, servers, solar cells, and power transmission systems.
- 9) Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.
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